



# Solving Your IC Package SI and SSN Problems: ICEMAX And It's Applications

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# Package Parasitics

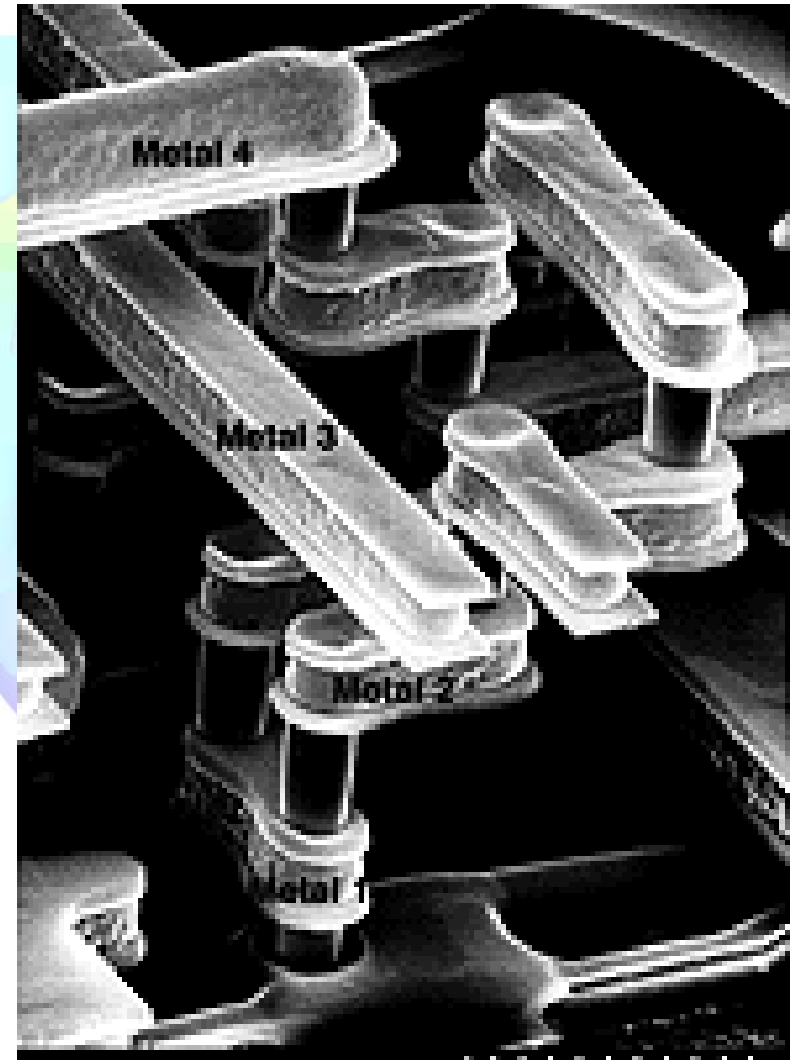
- Wires/traces are not ideal.

## Parasitics:

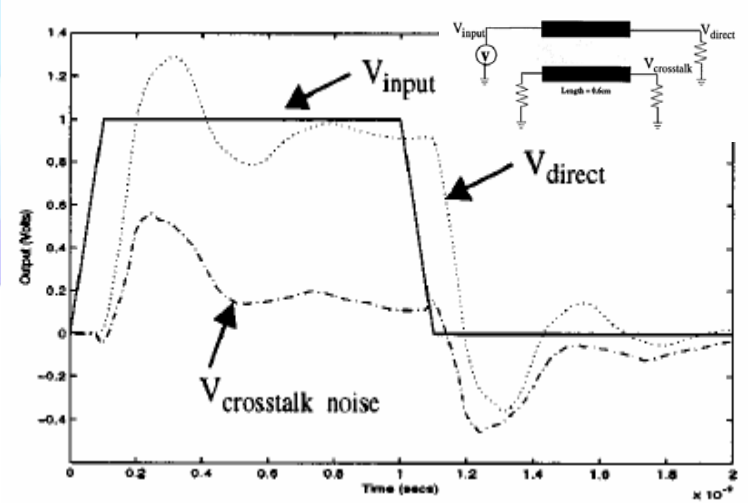
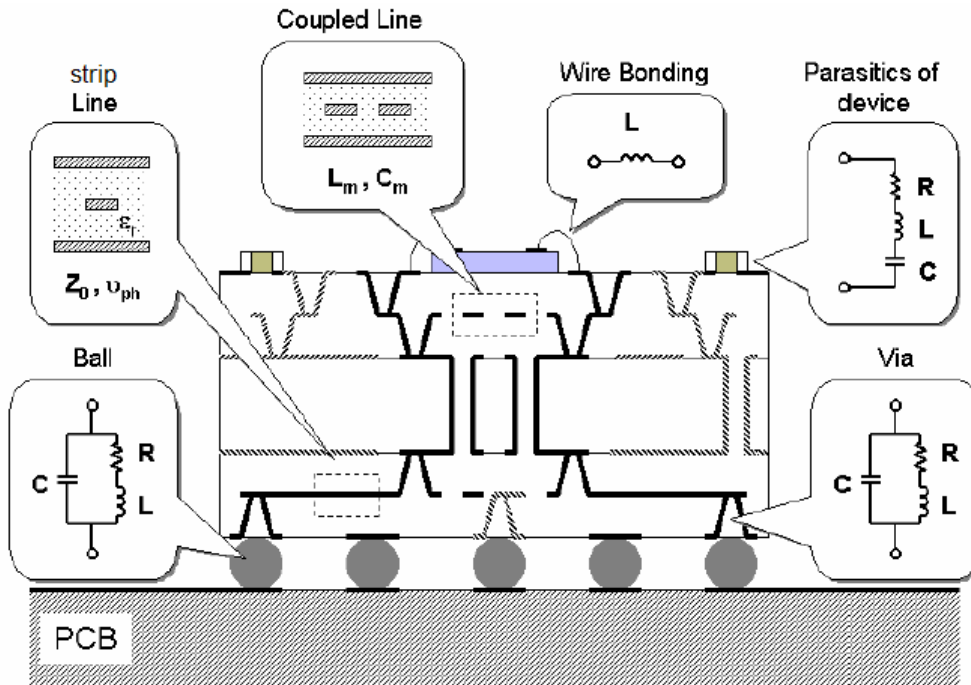
- Resistance
- Capacitance
- Inductance

- Why do we care?

- Impact on delay
- noise
- Power dissipation
- power distribution



# Signal Integrity and Power Concerns in Package

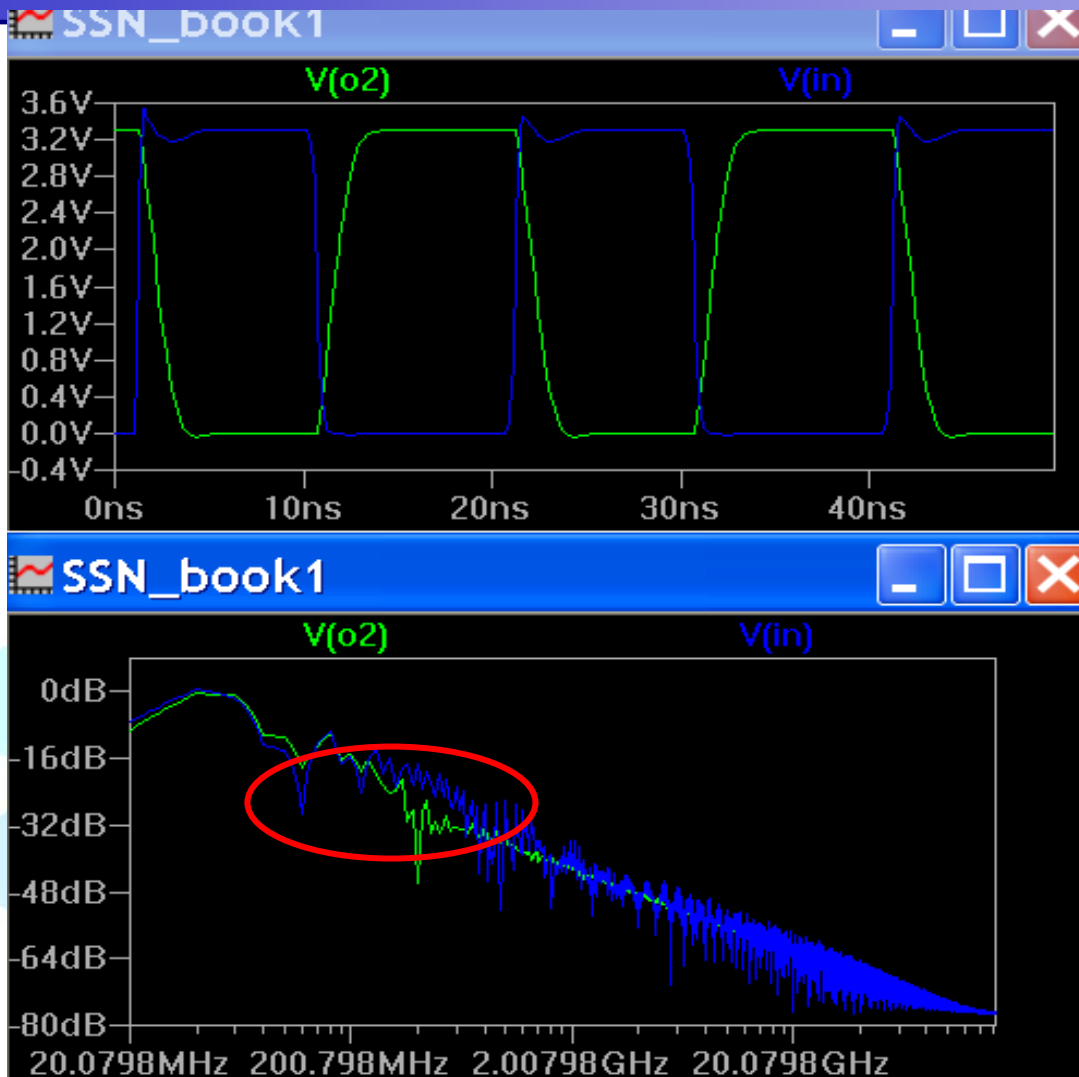


**Attenuation, dispersion and Delay:** propagation in medium, dielectric loss, conductor loss, skin effects

**Ringing:** impedance discontinuity

**Crosstalk:** energy coupling

# Distorted Signal Power Spectrum...



# Outline

- Theoretical background of ICEMAX
  - Quasi-static solver: why and how it works?
  - PEEC vs. Non-PEEC model
  - Numerical techniques: Finite Volume Method
- ICEMAX Critical Settings
  - Grounding vs. Non-grounding
  - Lumped vs. Distributed
  - Meshing setting
- Working with gerber files/CAD files and run ICEMAX – Project Demo
  - How to export Gerber file from package design?
  - Cadence Import
- Deliver SI and SSN analysis with ICEMAX results
  - Crosstalk analysis
  - SSN analysis

# When Quasi-static Fails?

Q: How long does light take from my nose to reach my eye?

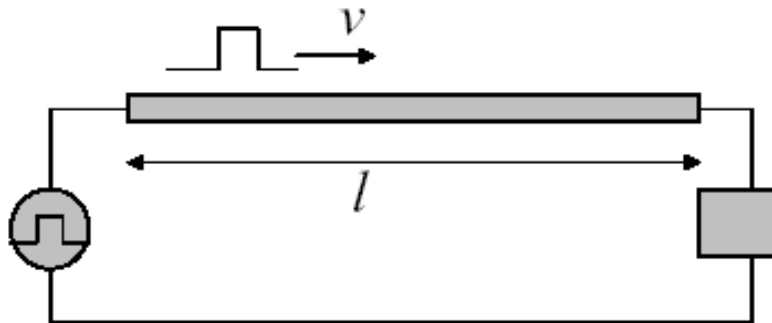
A:

$$c = 3 \times 10^8 \text{ m/s} = 30 \text{ cm/ns}, \quad L = 6 \text{ cm}$$

$$t = L/c = 6/30 = 0.2 \text{ ns} = 200 \text{ ps} \#$$

Q: The clock cycle of a 2GHz Pentium IV?

A: 500ps



Unequal potential on the conductor!

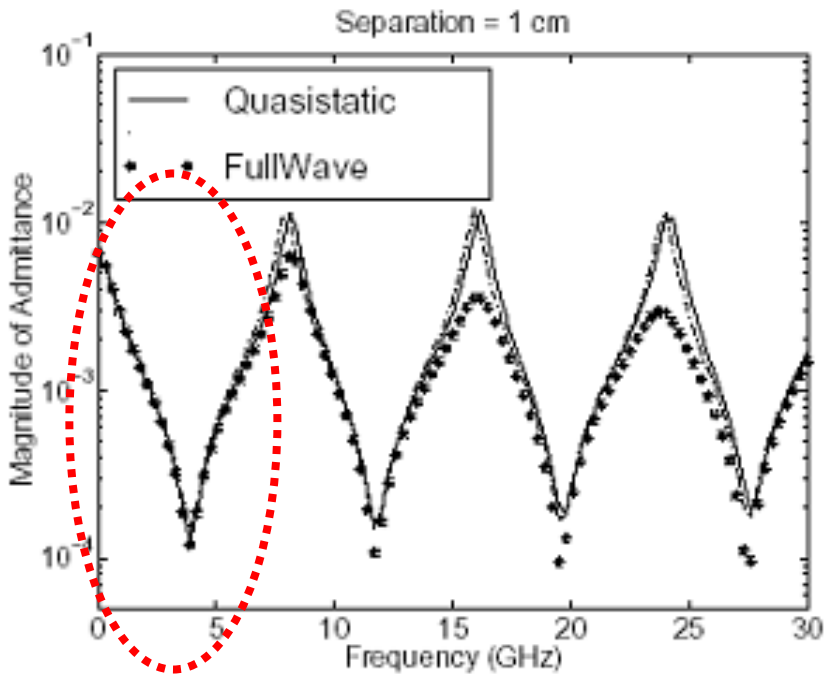
If  $t_{tof} > \sim 0.5t_r$  (rule in digital)

(where  $t_{tof} = l/v$ , called *time-of-flight*) OR

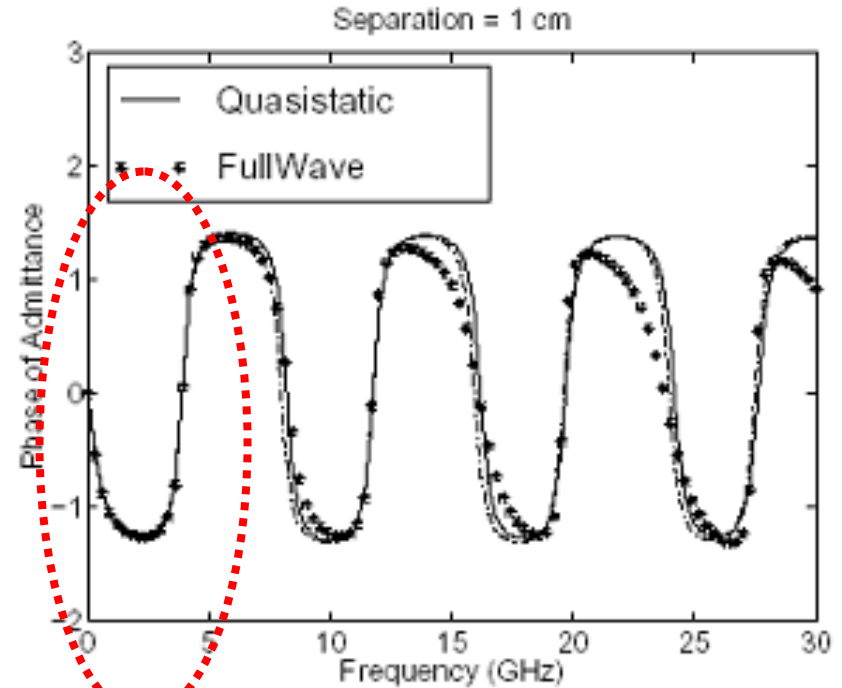
$l > \sim \lambda/10$  ( $\lambda$ : wavelength)

Transmission line effect is important!!

# Quasi-static vs. Full-wave

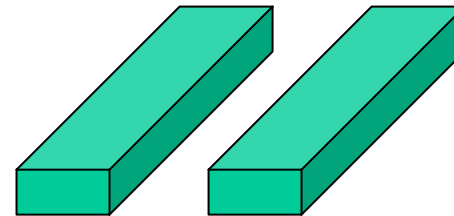
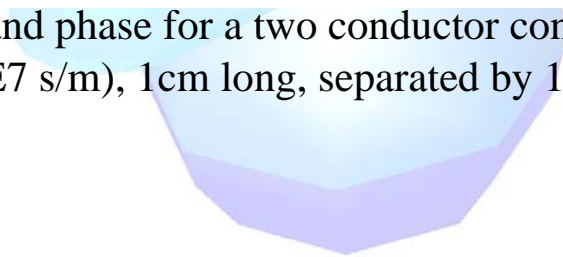


(a)



(b)

Magnitude and phase for a two conductor consisted transmission line with high resistivity ( $\sigma=5.8E7$  s/m), 1cm long, separated by 1 cm.



# Mathematic background of ICEMAX

- Quasi-static electromagnetics
  - Displacement current being ignored

$$\nabla \cdot D = 0$$

$$\nabla \cdot B = 0$$

$$\nabla \times E = -\frac{\partial B}{\partial t}$$

$$\nabla \times H = J + \frac{\partial D}{\partial t}$$

$$D = \epsilon E$$

$$B = \mu H$$

$$J = \sigma E$$

**Negligibly Small  
Displacement Current**

If ignoring the displacement current, Ampere's Law becomes an equation which describes the H-field and conduction current.

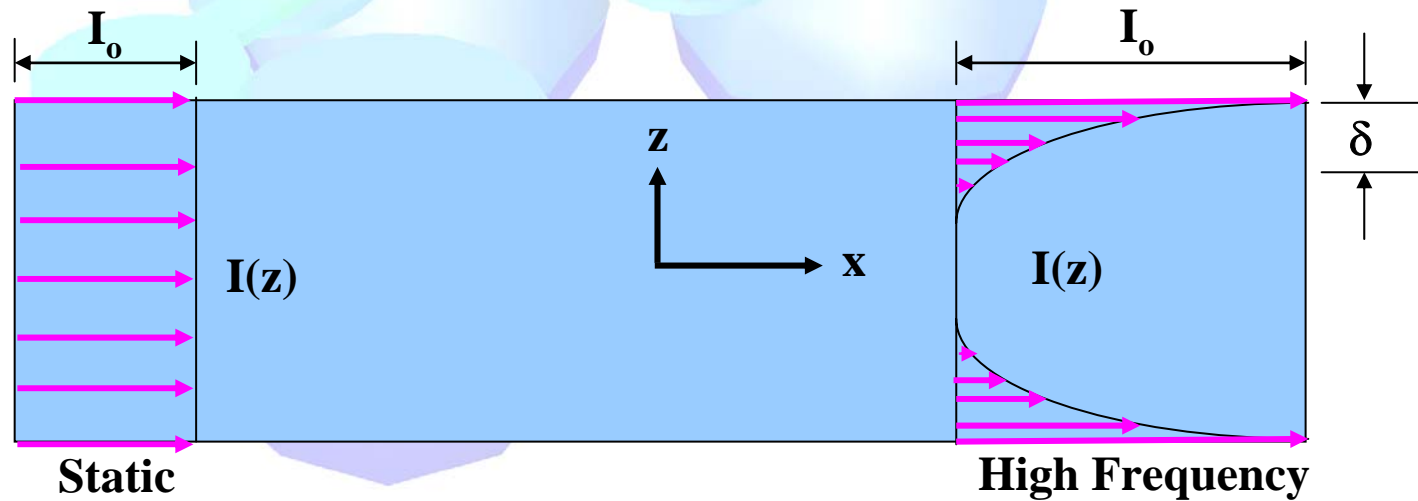
# Skin Effects and Conduction Current

$$I(z) = I_o \cdot e^{-(z-z_o)/\delta}$$

$$\delta = \sqrt{\frac{1}{\pi\mu\sigma f}}$$

Copper	$\rho=1/\sigma=1.68\times 10^{-8} \Omega\cdot\text{m}$
f (Hz)	$\delta$ ( $\mu\text{m}$ )
$10^4$	652.0
$10^6$	65.2
$10^8$	6.5
$10^9$	2.1
$10^{10}$	0.65

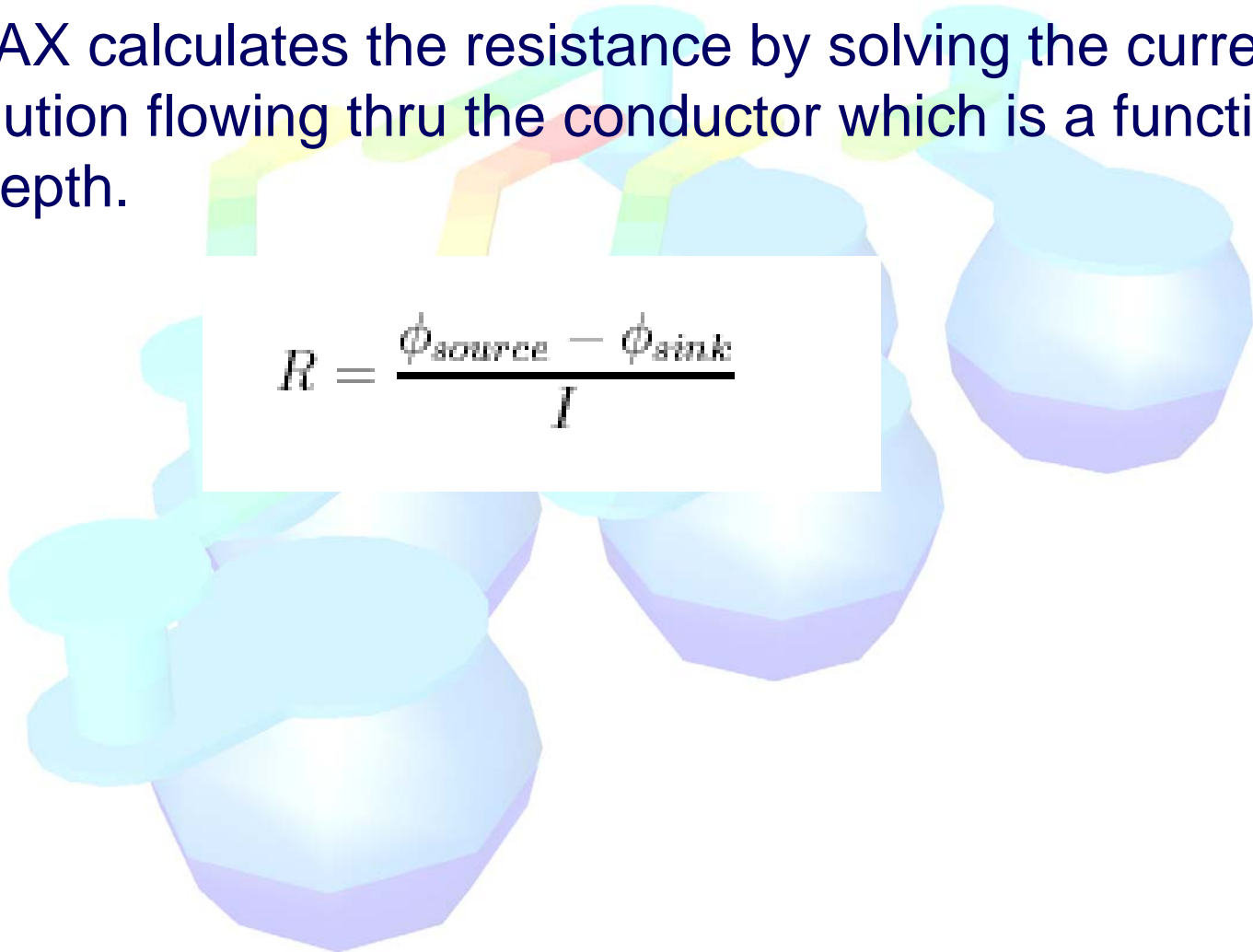
**Perfect Conductor:  $\delta=0$**



# Resistance Calculation

- ICEMAX calculates the resistance by solving the current distribution flowing thru the conductor which is a function of skin depth.

$$R = \frac{\phi_{source} - \phi_{sink}}{I}$$

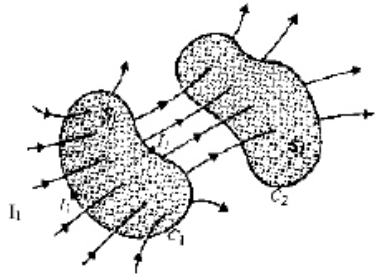


# Inductance: I

## Faraday's Law

$$\oint_C \vec{E} \cdot d\vec{l} = - \int_S \frac{\partial \vec{B}}{\partial t} \cdot d\vec{s} \Rightarrow V = - \frac{d\Phi}{dt}$$

$$\Phi = \iint_S \vec{B} \cdot d\vec{s} = LI = \text{magnetic flux cross surface } S$$



Mutual flux:

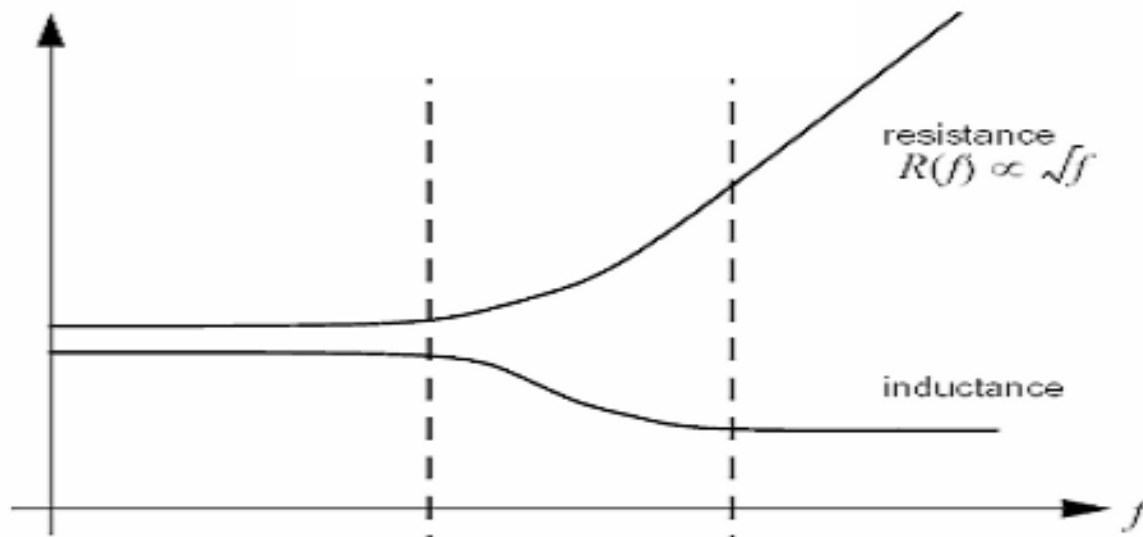
$$\Phi_{12} = \int_{S_2} \vec{B}_1 \cdot d\vec{s}_2 = L_{12} I_1$$

$$L = \frac{d\Phi}{dI}$$

# Inductance: II

- Inductance

- Total inductance including internal inductance and external inductance
- Internal inductance changes due to skin effects
- External inductance doesn't change w.r.t frequency



# Inductance Calculation

Magnetic Vector Potential:  $\vec{A}$

$$\vec{B} = \nabla \times \vec{A}$$

$$\left\{ \begin{array}{l} -\nabla \phi = \frac{\mathbf{J}}{\sigma} + j\omega \frac{\mu}{4\pi} \int_v \mathbf{J}(\omega) G(\mathbf{x}, \mathbf{x}') dV \\ \nabla \cdot \mathbf{J} = 0 \\ \nabla^2 \mathbf{A} = \mu \mathbf{J} \end{array} \right.$$

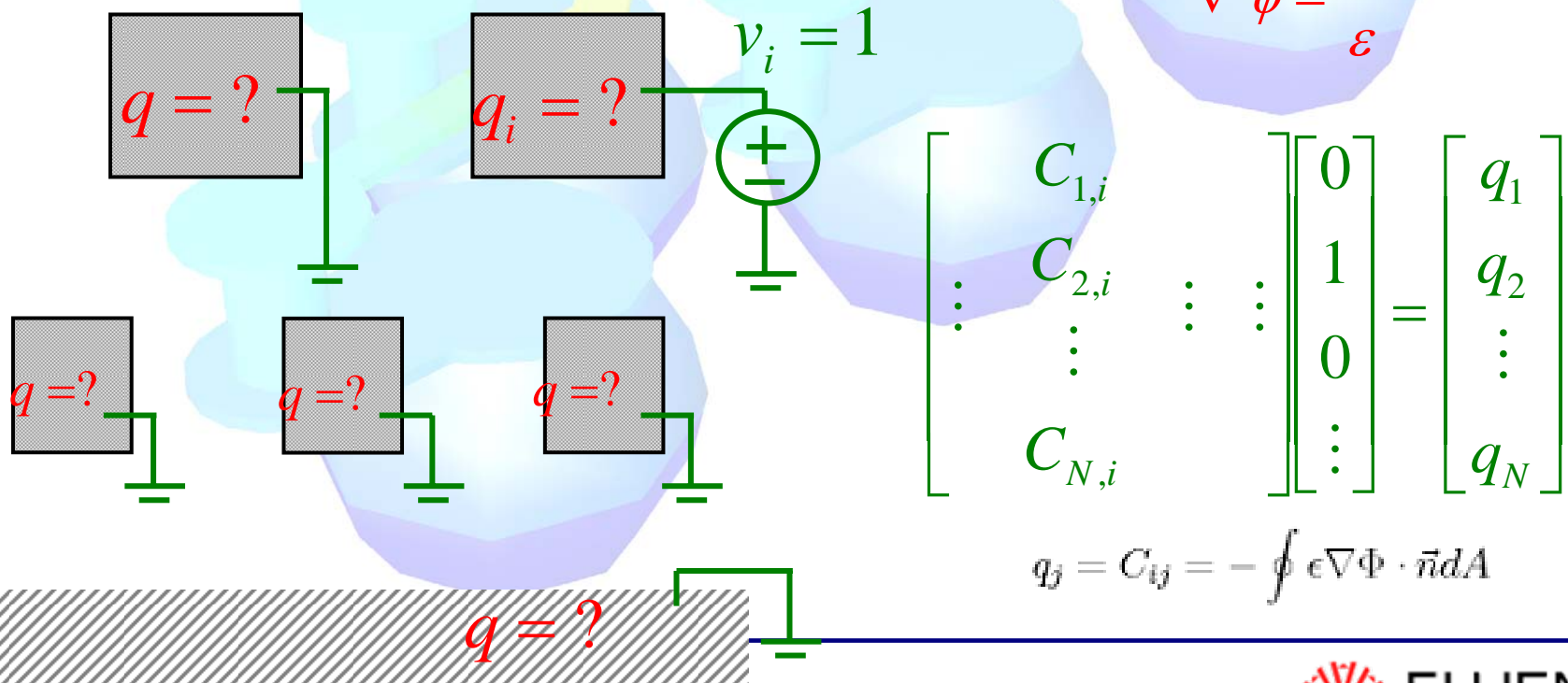
$$L_{ij} = \int \mathbf{J}(\mathbf{x}_i) \cdot \mathbf{A}_j(\mathbf{x}_i) d^3 x$$

Infinite space

$$L_{ij} = \frac{\mu}{4\pi} \iint \frac{\mathbf{J}(\mathbf{x}_i) \cdot \mathbf{J}(\mathbf{x}'_j)}{|\mathbf{x}_i - \mathbf{x}'_j|} d^3 x_i d^3 x'_j$$

# Capacitance Extraction Solution Procedure

- For  $i = 1$  to  $N$ ,
  - apply one volt to conductor  $i$  and ground all the others
  - solve the electrostatic problem and find the resulting vector of charges on all conductors
  - that is the  $i$ -th column of the conductance matrix



# Partial Inductance and PEEC

- PEEC = Partial Equivalent Element Circuit
- A loop can be broken into smaller sections
- Inductances can be computed for each section
- The loop can be re-generated with the partial inductances
- And the loop inductance can be calculated
- This is *purely* for calculation purposes



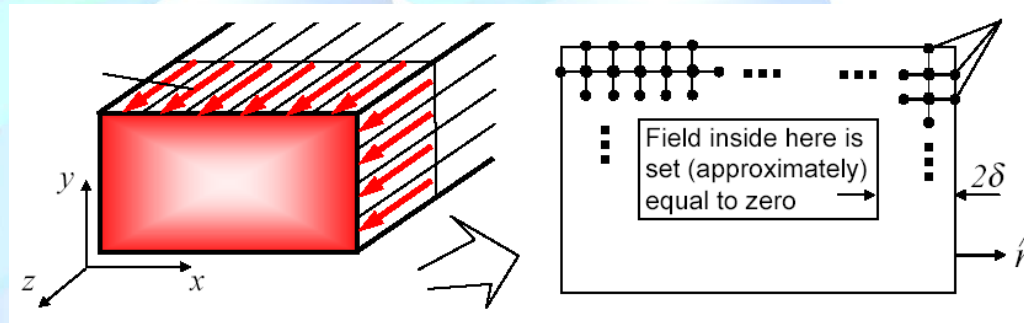
$$L = L_1 + L_2 - 2M$$

**Quiz: How much is the inductance of a typical bondwire??**

# PEEC : I

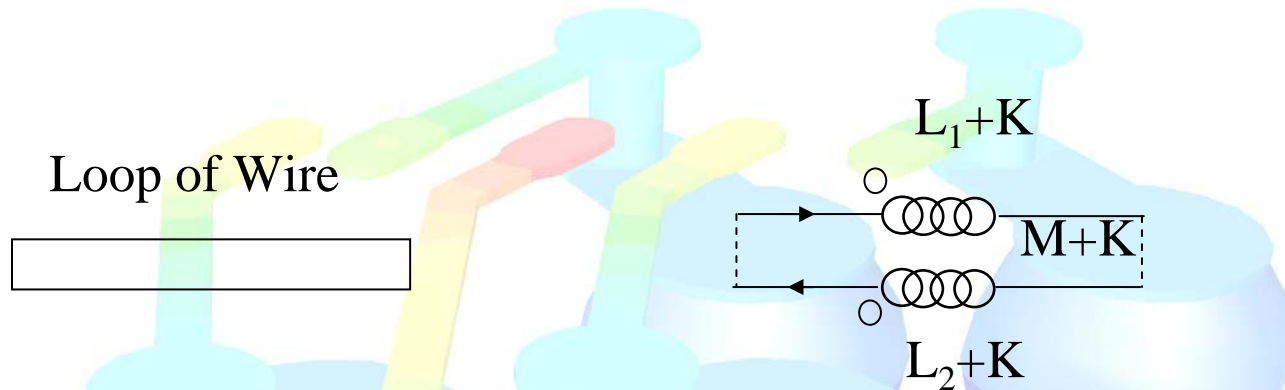
- Pros and Cons

- Without prior knowledge of the return path, a current loop can be reconstructed
- Can exactly evaluate the skin-depth effects by discretizing the conductors as a combination of many thin-wires (filaments)
- Good for rectangular dominated geometry due to the filaments discretization (good applications: on-chip parasitic modeling)



- High-cost, not feasible for high-end package extraction

# PEEC: Non-uniqueness of PEEC



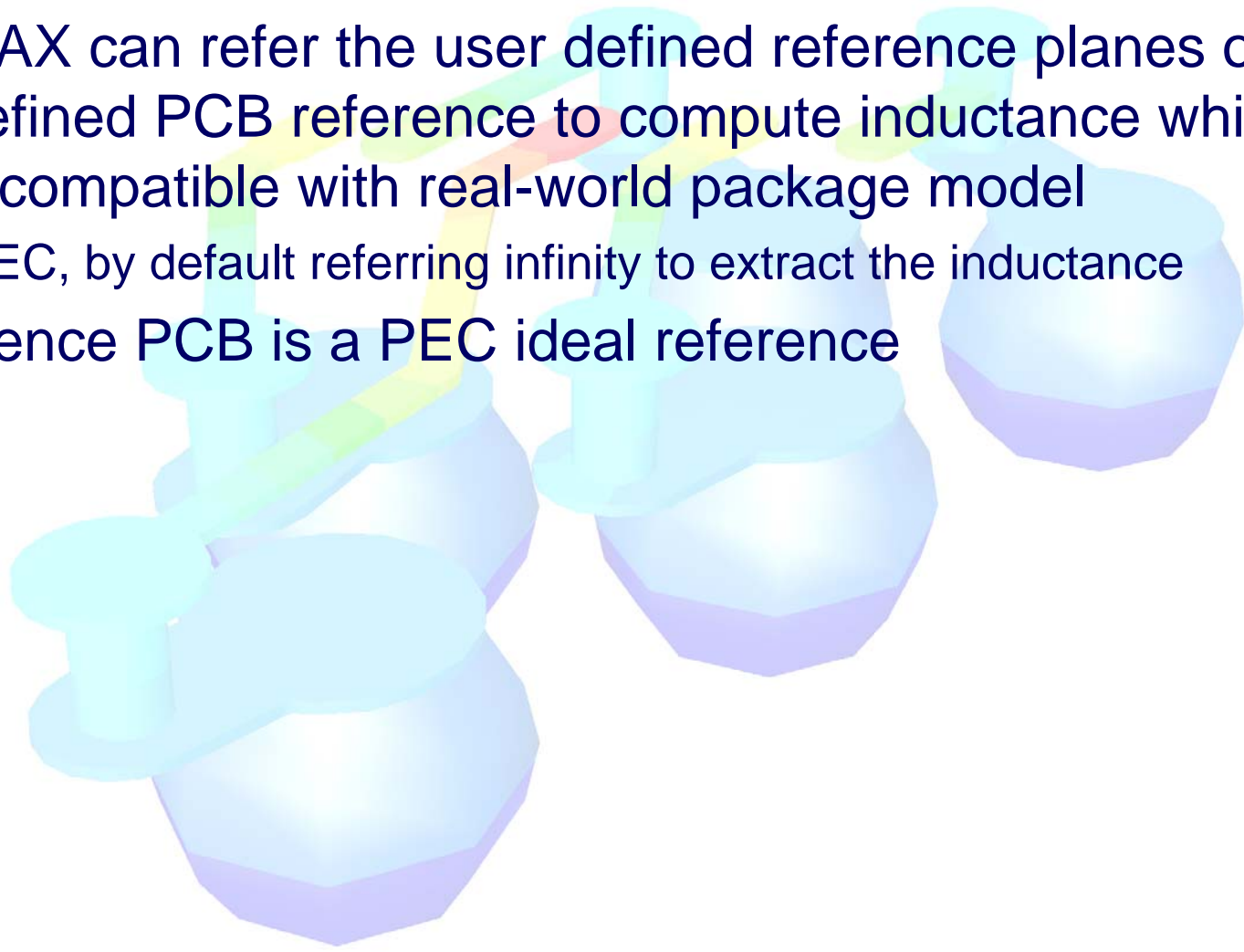
$$L = (L_1 + K) + (L_2 + K) - 2(M + K)$$

If a constant is added to the self and mutual inductance, loop inductance does not change.

However, *loop inductance* is always unique.

# How ICEMAX Deals with Inductance

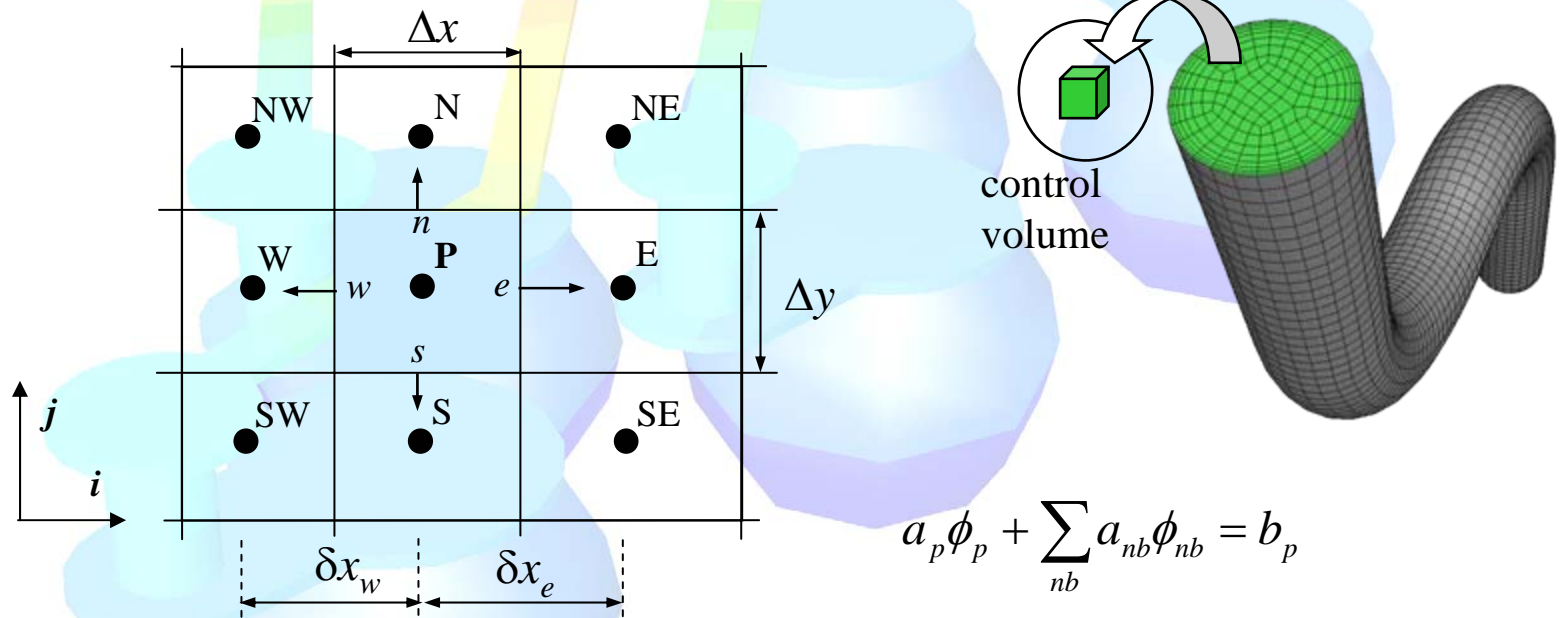
- ICEMAX can refer the user defined reference planes or/and the defined PCB reference to compute inductance which is more compatible with real-world package model
  - PEEC, by default referring infinity to extract the inductance
- Reference PCB is a PEC ideal reference



# Numerical Tech – Finite Volume Method Overview

- **Finite volume method**

- Domain is discretized into a finite set of control volumes or cells

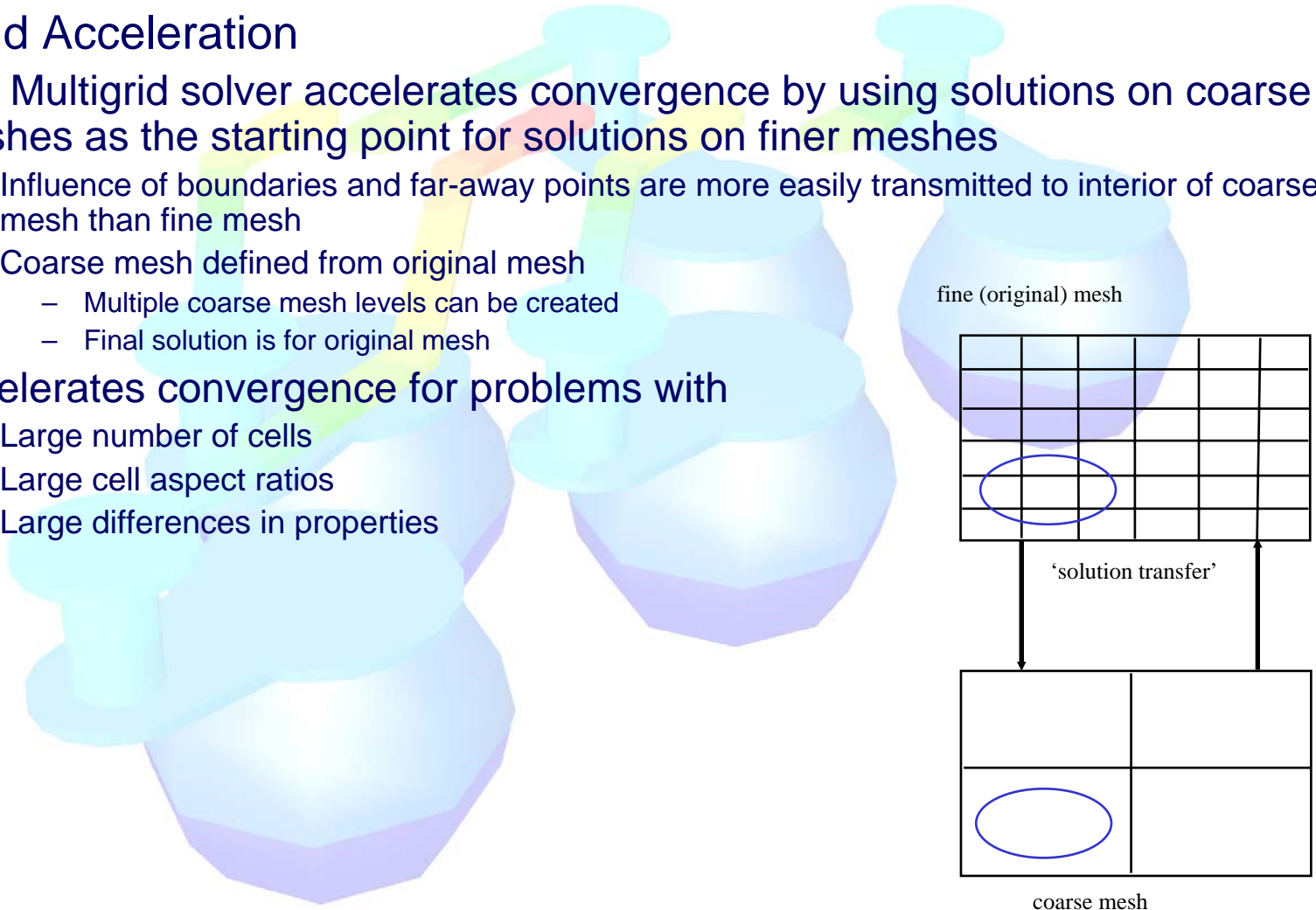


- The net flux through the control volume boundary is the sum of integrals over the four control volume faces (six in 3D).

# Numerical Tech – Finite Volume Meshing

- Multigrid Acceleration

- The Multigrid solver accelerates convergence by using solutions on coarse meshes as the starting point for solutions on finer meshes
  - Influence of boundaries and far-away points are more easily transmitted to interior of coarse mesh than fine mesh
  - Coarse mesh defined from original mesh
    - Multiple coarse mesh levels can be created
    - Final solution is for original mesh
- Accelerates convergence for problems with
  - Large number of cells
  - Large cell aspect ratios
  - Large differences in properties



# ICEMAX Critical Settings

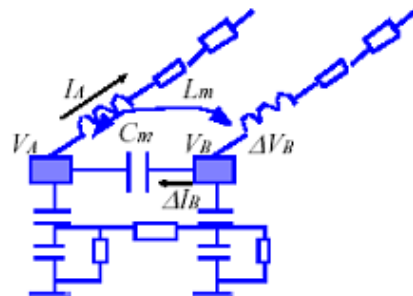
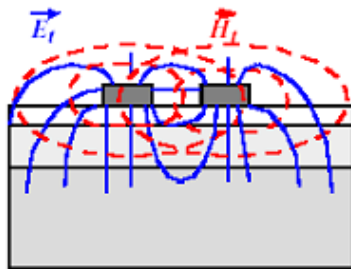
- **Grounding vs. Non-grounding G/P**
  - Exclude G/P will ignore the ground/power plane nets while treating them as a non-ideal reference planes for signal nets.
  - Include G/P
    - IF the ground plane filter (which is based on how many solderballs are connected to the ground/power planes) setting is greater than the actual solderballs that the planes have, any ground/power nets will be treated as signal nets, thus the PEEC-like (referring to PCB) inductance will be calculated.
    - IF the ground plane filter setting is less than the actual solderballs that the planes have, any ground/power nets will be treated as a reference for signal nets, however, the self value of ground/power nets will be reported separately.
- **Lumped vs. Distributed**
  - Lumped setting reports any net as a single series RLC circuit
  - Distributed model either reports a model with respect to geometry discontinuities or an averaged distribution of the total RLC value
- **Meshing settings**

# Applications of ICEMAX: Crosstalk

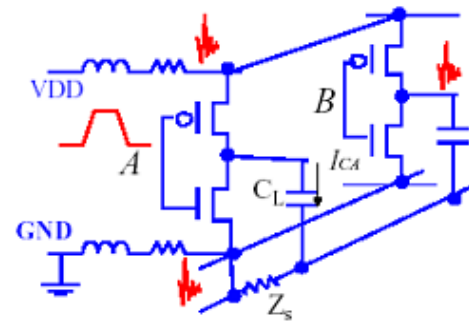
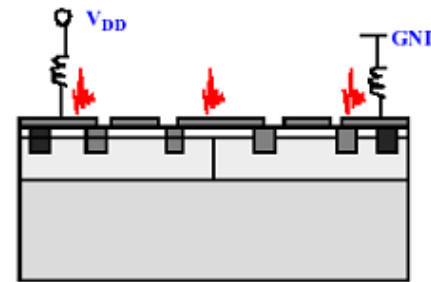
- Crosstalk

- Two contributions: capacitive coupling and inductive coupling
- The mutual capacitance and the mutual inductance plays important role

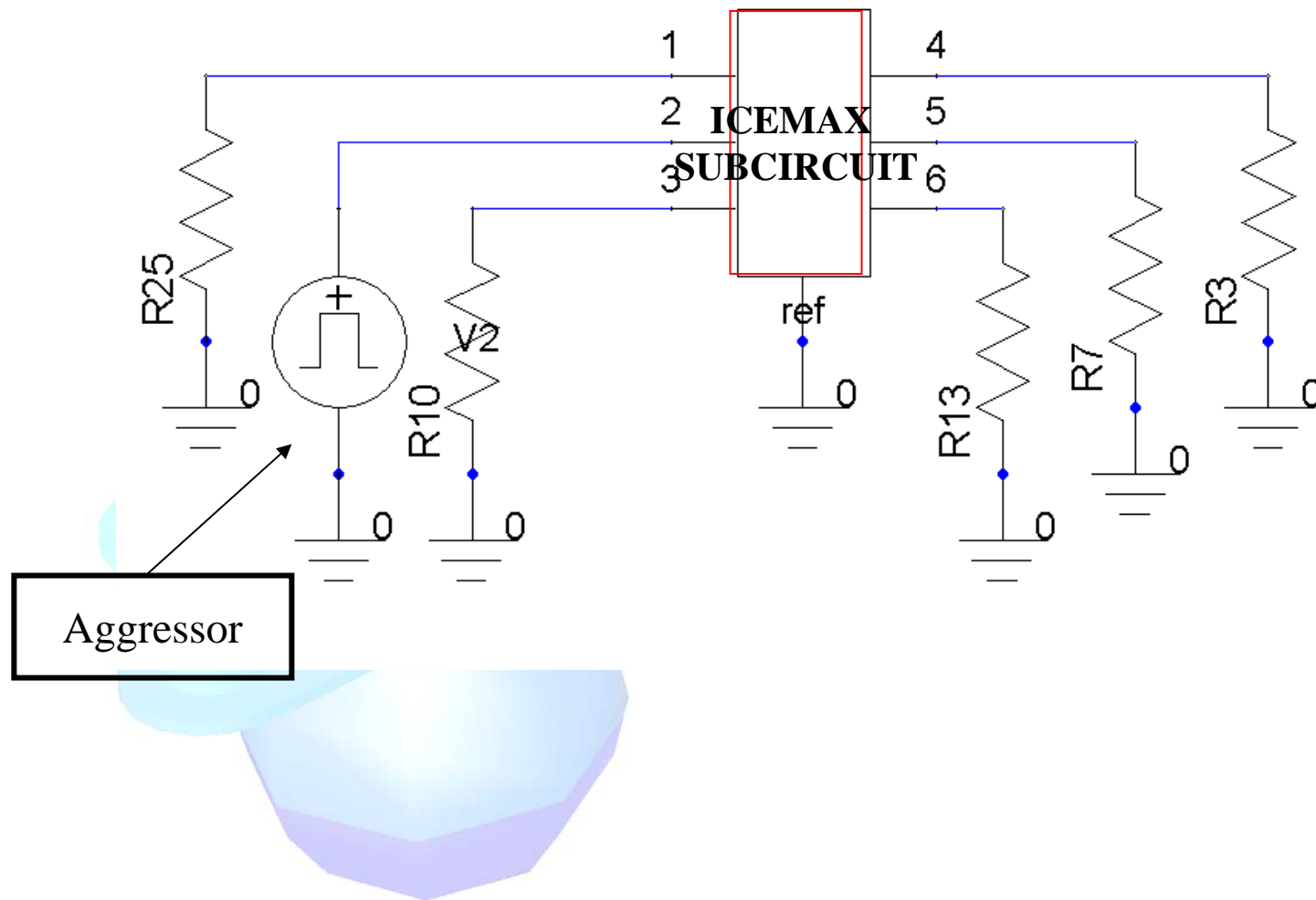
□ Near Field Coupling



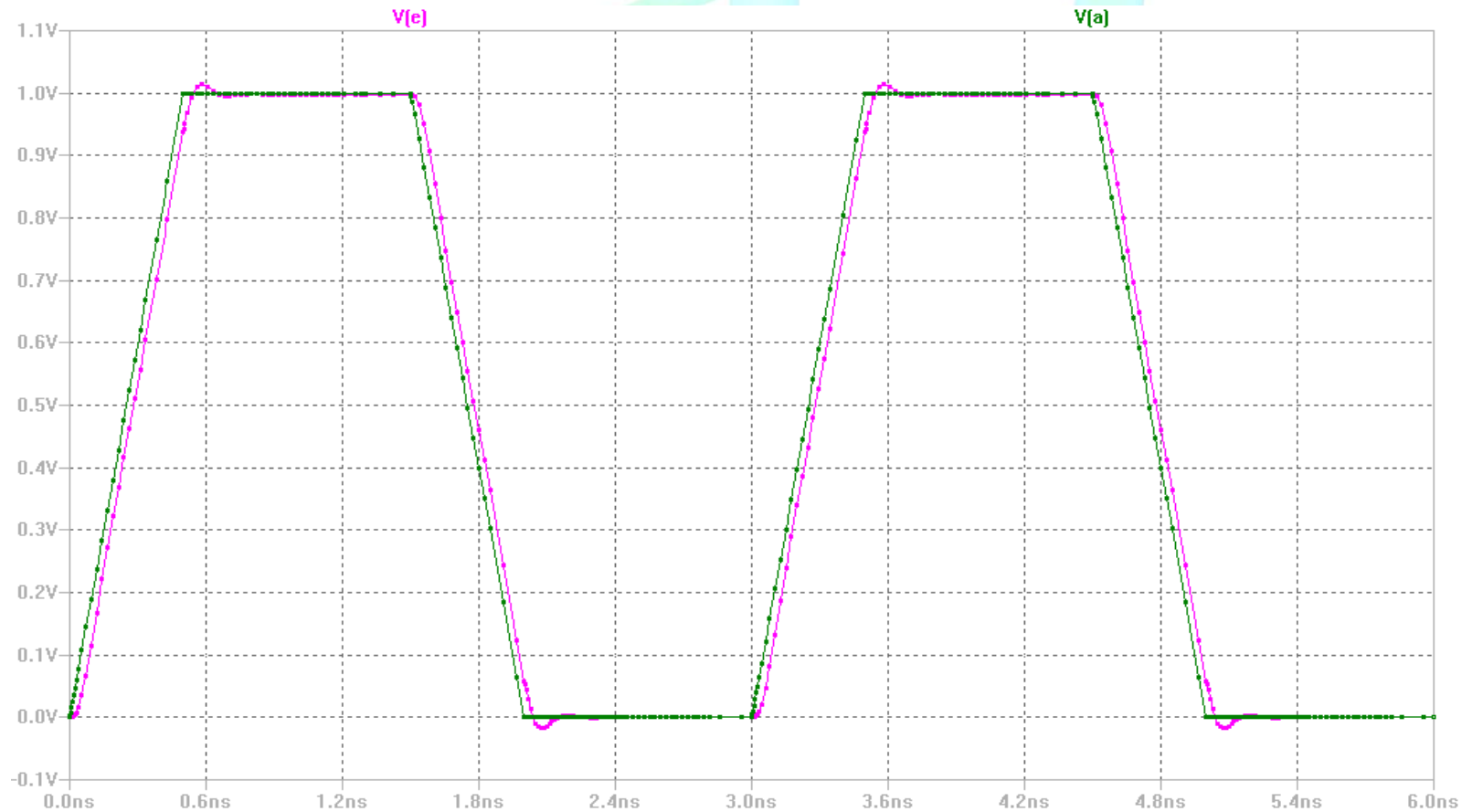
□ Power/Ground Crosstalk  
□ Signal Return Crosstalk



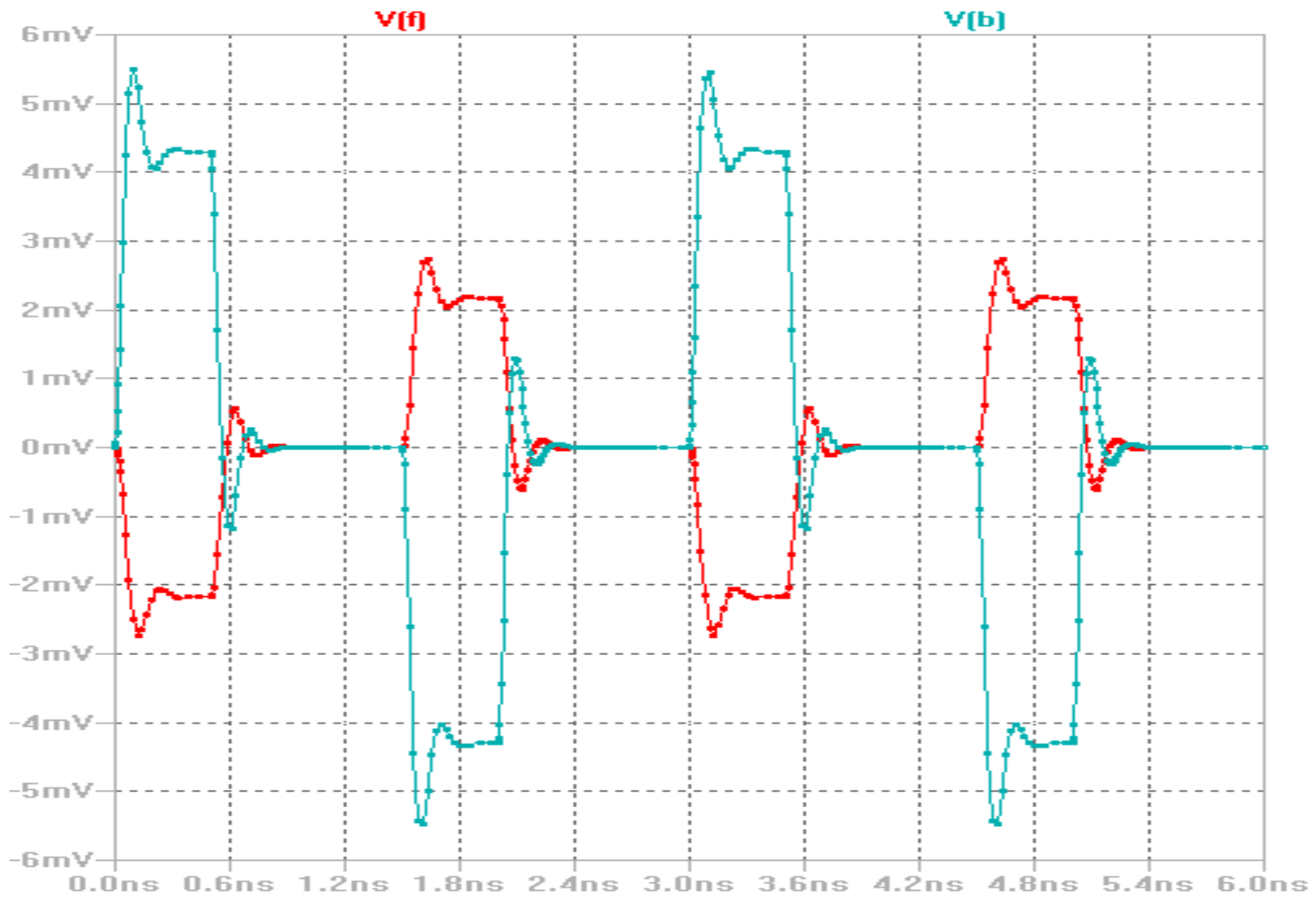
# Crosstalk Example: 3 Coupled Nets



# Aggressor Input and Output

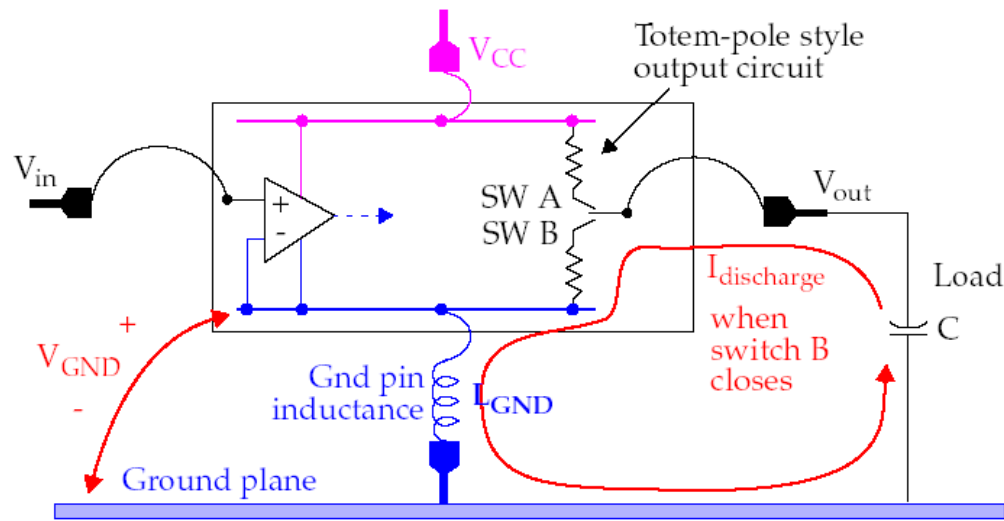


# Victim 1 Near-end and Far-end Crosstalk



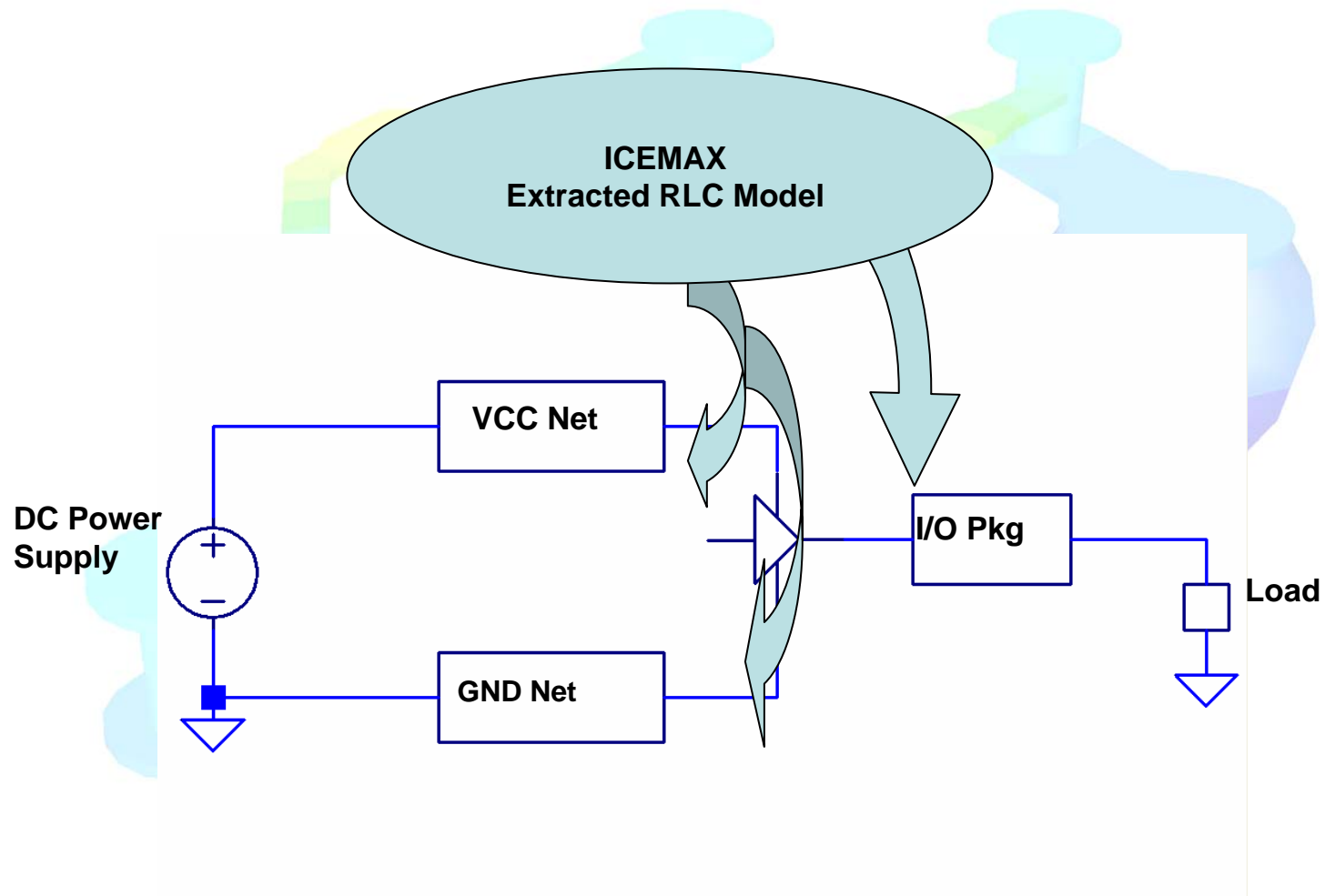
# Application Example 2: SSN

- SSN is due to the non-ideal reference plane and ground/power connection effects



$$V_{GND} = L_{GND} \frac{dI_{discharge}}{dt}$$

# Using ICEMAX Model for SSN



# A Simple SSN Example

